

## Multi-Cure® 921-GEL Potting Resin or Adhesive for Plastics and Metals

### APPLICATIONS

- **Shallow Potting (0.25"/6 mm)**
- **Rigid Adhesive Bonding**

### FEATURES

- **UV Light Curing**
- **Secondary Heat Cure Capability**
- **Activator Cure Capability**

### RECOMMENDED SUBSTRATES

- **ABS**
- **PA**
- **PI**
- **PU**
- **Ceramic**
- **Metals**

Dymax Multi-Cure® 921-GEL is designed for rapid bonding and shallow potting in a wide variety of substrates including metal, glass, ceramic, and thermoset or filled plastics. Dymax 921-GEL is a Multi-Cure material specially formulated to cure primarily with UV/visible light and includes a secondary heat or activator curing function in applications where shadowed areas exist. Dymax Multi-Cure materials contain no nonreactive solvents. Their ability to cure in seconds enables faster processing, greater output, and lower processing costs. When cured with Dymax light-curing spot lamps, focused- beam lamps, or flood lamps, they deliver optimum speed and performance for industrial assembly. Dymax lamps offer the ideal balance of UV and visible light for the fastest, deepest cures. This product is in full compliance with RoHS directives 2015/863/EU.

### UNCURED PROPERTIES \*

Property	Value	Test Method
Solvent Content	No Nonreactive Solvents	N/A
Chemical Class	Acrylated Urethane	N/A
Appearance	Translucent Light Yellow Gel	N/A
Soluble in	Organic Solvents	N/A
Density, g/ml	1.07	ASTM D1875
Viscosity, cP (20 rpm)	25,000 (nominal)	ASTM D2556

### CURED MECHANICAL PROPERTIES \*

Property	Value	Test Method
Durometer Hardness	D80	ASTM D2240
Tensile at Break, MPa [psi]	25 [3,640]	ASTM D638
Elongation at Break, %	30	ASTM D638
Modulus of Elasticity, Mpa [psi]	583 [84,650]	ASTM D638

### OTHER CURED PROPERTIES \*

Property	Value	Test Method
Refractive Index (20° C)	1.50	ASTM D542
Boiling Water Absorption, % (2 h)	3.7	ASTM D570
Water Absorption, % (25° C, 24 h)	1.3	ASTM D570
Linear Shrinkage, %	0.20	DSTM 614‡
Glass Transition T <sub>g</sub> , °C	79	DSTM 256‡
CTE <sub>α1</sub> , μm/m/°C	65	DSTM 610‡
CTE <sub>α2</sub> , μm/m/°C	220	DSTM 610‡

\* Not Specifications  
 N/A Not Applicable  
 ‡ DSTM Refers to Dymax Standard Test Method

### ADHESION

Substrate	Recommendation
ABS acrylonitrile-butadiene-styrene	✓
EP epoxy, FR4 Board	○
PA polyamide	✓
PC polycarbonate	✓
PEEK polyetheretherketone	○
PI polyimide	✓
PU polyurethane	✓
SAN styrene-acrylonitrile	✓
TPU thermoplastic polyurethane	✓
CER ceramic	✓
GL glass: borosilicate, quartz, mica	✓
AL aluminum	✓
BR brass	✓
CRS cold rolled steel	✓
CU Copper	✓
SS stainless steel	✓

✓ Recommended Adhesive      ○ Limited Applications  
 st Requires Surface Treatment (e.g. plasma, corona treatment, etc.)



**CURING GUIDELINES**

Fixture time is defined as the time to develop a shear strength of 0.1 N/mm<sup>2</sup> [10 psi] between glass slides. Actual cure time typically is 3 to 5 times fixture time.

Dymax Curing System (Intensity)	Fixture Time or Belt Speed <sup>A</sup>
2000-EC (50 mW/cm <sup>2</sup> ) <sup>A</sup>	4
5000-EC (200 mW/cm <sup>2</sup> ) <sup>A</sup>	2
365 nm RediCure™ LED Flood (450 mW/cm <sup>2</sup> ) <sup>B</sup>	2
385 nm PrimeCure® LED Flood (850 mW/cm <sup>2</sup> ) <sup>B</sup>	2
405 nm VisiCure® LED Flood (950 mW/cm <sup>2</sup> ) <sup>B</sup>	7
BlueWave® 200 (10 W/cm <sup>2</sup> ) <sup>A</sup>	2
UVCS Conveyor with 5000-EC (200 mW/cm <sup>2</sup> ) <sup>C</sup>	7 m/min [ 23 ft/min]
UVCS Conveyor with Fusion F300S (2.5 W/cm <sup>2</sup> ) <sup>C</sup>	7 m/min [23 ft/min]

- A** Fixture times/belt speeds are typical for curing thin films through 100% UV and light-transmitting substrates. Light-obstructing substrates may require longer cure times.
- B** Intensity was measured over the UVA range (320-395 nm) using a Dymax ACCU-CAL™ 50 Radiometer.
- C** Intensity was measured over the UVA/Visible range (350-450 nm) using a Dymax ACCU-CAL™ 50-LED Radiometer.
- D** At 53 mm [2.1 in] focal distance. Maximum speed of conveyor is 8.2 m/min [27 ft/min]. Intensity was measured over the UVA range (320-395 nm) using the Dymax ACCU-CAL™ 150 Radiometer.

**SECONDARY HEAT CURE**

Heat can be used as a secondary cure mechanism where the resin cannot be cured with light. The following heat-cure schedule may be used:

Temperature	Time*
110°C [230°F]	60 minutes
120°C [250°F]	30 minutes
150°C [300°F]	15 minutes

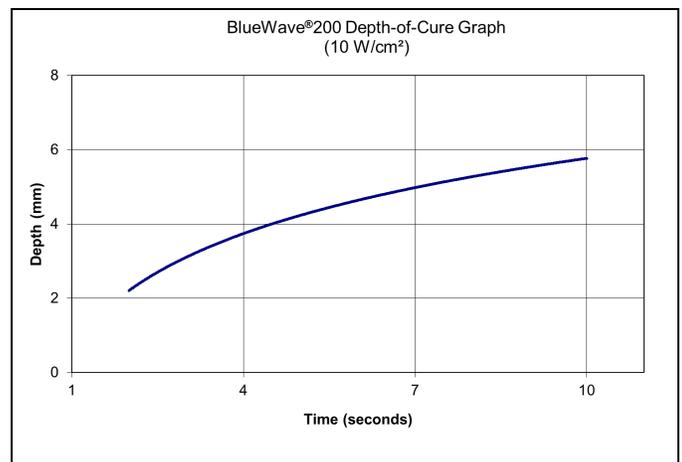
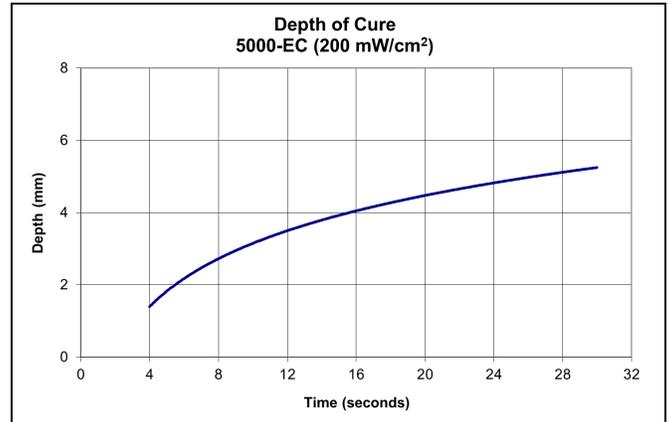
\*Note: Actual heat cure time may vary due to part configuration, volume of material applied, and oven efficiency.

Full cure is best determined empirically by curing at different times and intensities, and measuring the corresponding change in cured properties such as tackiness, adhesion, hardness, etc. Full cure is defined as the point at which more light exposure no longer improves cured properties. Higher intensities or longer cure times may degrade Dymax light-curable masks.

Dymax recommends that customers employ a safety factor by curing longer and/or at higher intensities than required for full cure. Although Dymax Application Engineering can provide technical support and assist with process development, each customer must ultimately determine and qualify the appropriate curing parameters required for their unique application.

**DEPTH OF CURE**

The graph below shows the increase in depth of cure as a function of exposure time. A 9.5 mm [0.37 in] diameter specimen was cured in a polypropylene mold and cooled to room temperature. It was then released from the mold and the cure depth was measured.



**OPTIMIZING PERFORMANCE AND HANDLING**

1. This product cures with exposure to UV and visible light. Exposure to ambient and artificial light should be kept to a minimum before curing. Dispensing components including needles and fluid lines should be 100% light blocking, not just UV blocking.
2. All bond surfaces should be clean and free from grease, mold release, or other contaminants prior to dispensing the adhesive.
3. Cure speed is dependent upon many variables, including lamp intensity, distance from the light source, required depth of cure, bond gap, and percent light transmission of the substrate.
4. Oxygen in the atmosphere may inhibit surface cure. Surfaces exposed to air may require high-intensity UV light to produce a dry surface cure. Flooding the bond area with an inert gas, such as nitrogen, can also reduce the effects of oxygen inhibition.
5. Parts should be allowed to cool after cure before testing and subjecting to any loads.
6. In rare cases, stress cracking may occur in assembled parts. Three options may be explored to eliminate this problem. One option is to heat anneal the parts to remove molded-in stresses. A second option is to open the gap between mating parts to reduce stress caused by an interference fit. The third option is to minimize the amount of time the liquid adhesive remains in contact with the substrate(s) prior to curing.
7. Light curing generally produces some heat. If necessary, cooling fans can be placed in the curing area to reduce the heating effect on components.
8. At the point of curing, an air exhaust system is recommended to dissipate any heat and vapors formed during the curing process.

**DISPENSING THE RESIN**

This material may be dispensed with a variety of manual, semi-automated and fully automated fluid delivery systems. Dymax has several dispensing systems that may be suitable for use with this material such as our model 110 mountable atomizing needle valve or SG-100-RS handheld spray gun. Small area applications including beads and small dots can be achieved using hand-held dispensers such as our SD-100 syringe dispenser and our Model 400 needle valve systems. These valve systems can be used in a manual, semi-automated or fully automated application. Actual dispensing options, vary by material properties. Questions relating to and defining the best fluid delivery system and curing equipment for specific applications should be discussed with the Dymax Application Engineering Team.

**STORAGE AND SHELF LIFE**

Store the material in a cool, dark place when not in use. Do not expose to light. This product may polymerize upon prolonged exposure to ambient and artificial light. Keep covered when not in use. This material has an 18-month shelf life from date of manufacture, unless otherwise specified, when stored between 10°C (50°F) and 35°C (90°F) in the original, unopened container.

**CLEANUP**

Uncured material may be removed from dispensing components and parts with organic solvents. Cured material will be impervious to many solvents and difficult to remove. Cleanup of cured material may require mechanical methods such as ultrasonic bath, water jet, vacuum tweezers, air knife and/ or warming to aid in the removal.

**GENERAL INFORMATION**

This product is intended for industrial use only. Keep out of the reach of children. Avoid breathing vapors. Avoid contact with skin, eyes, and clothing. Wear impervious gloves. Repeated or continuous skin contact with uncured material may cause irritation. Remove material from skin with soap and water. Never use organic solvents to remove material from skin and eyes. For more information on the safe handling of this material, please refer to the Safety Data Sheet before use.

The data provided in this document are based on historical testing that Dymax performed under laboratory conditions as they existed at that time, and are for informational purposes only. The data are neither specifications nor guarantees of future performance in a particular application. Dymax does not guarantee that this product's properties are suitable for the user's intended purpose.

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